



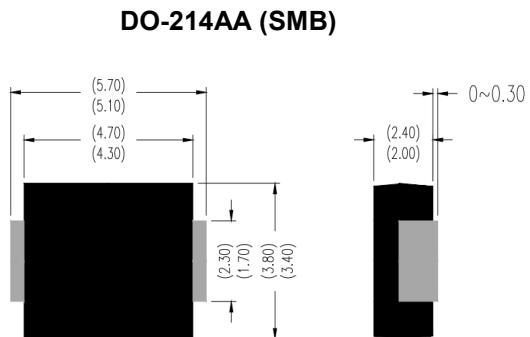
Surface Mount Schottky Rectifier

Features

- Low profile package
- Ideal for automated placement
- Guardring for overvoltage protection
- Low power losses, high efficiency
- High forward surge capability
- AEC-Q101 qualified
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

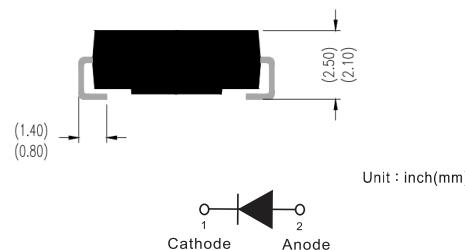
Typical Applications

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.



Mechanical Data

- **Package:** DO-214AA (SMB)
Molding compound meets UL 94 V-0 flammability rating, RoHS-compliant, halogen-free
- **Terminals:** Tin plated leads, solderable per J-STD-002 and JESD22-B102
- **Polarity:** Cathode line denotes the cathode end



Unit : inch(mm)

■Maximum Ratings ($T_a=25^\circ\text{C}$ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	SS32BQ	SS33BQ	SS34BQ	SS35BQ	SS36BQ	SS38BQ	SS310BQ	SS315BQ	SS320BQ
Repetitive peak reverse voltage	V_{RRM}	V	20	30	40	50	60	80	100	150	200
Average rectified output current @60Hz sine wave, resistance load, T_c (FIG.1)	I_o	A						3.0			
Surge(non-repetitive)forward current @60Hz half-sine wave, 1 cycle, $T_a=25^\circ\text{C}$	I_{FSM}							100			
Storage temperature	T_{stg}	$^\circ\text{C}$						-55 ~+150			
Junction temperature	T_j	$^\circ\text{C}$						-55 ~+150		-55 ~+175	

■Electrical Characteristics ($T_a=25^\circ\text{C}$ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	SS32BQ	SS33BQ	SS34BQ	SS35BQ	SS36BQ	SS38BQ	SS310BQ	SS315BQ	SS320BQ
Maximum instantaneous forward voltage drop per diode	V_F	V	$I_{FM} = 3.0\text{A}$		0.55			0.75		0.85		0.95
Maximum DC reverse current at rated DC blocking voltage per diode @ $V_{RM}=V_{RRM}$	I_{RRM}	mA	$T_a=25^\circ\text{C}$		0.50					0.10		
			$T_a=100^\circ\text{C}$		10					5		

■Thermal Characteristics ($T_a=25^\circ\text{C}$ Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	SS32BQ	SS33BQ	SS34BQ	SS35BQ	SS36BQ	SS38BQ	SS310BQ	SS315BQ	SS320BQ	
Thermal resistance	$R_{\theta J-A}$	$^\circ\text{C/W}$	55 ¹⁾									
	$R_{\theta J-C}$		20 ¹⁾									

Note:

(1) Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.6" x 0.6" (16 mm x 16mm) copper pad areas



■ Characteristics(Typical)

